L Number	Hits	S arch Text	DB	Tim stamp
1	670	titanium with (diffus$5 n ar2 (b nd$5 w ld$5))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/20 09:09
8	109	(titanium with (diffus$5 near2 (bond$5 weld$5))) and (groove channel) and (cut$5 slic$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/20 08:49
22	78	(titanium with (diffus$5 near2 (bond$5 weld$5))) and ((228/157).CCLS.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/20 09:00
15	218	(228/157).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/20 09:09
29	11	(("5031483") or ("5204055") or ("5340656") or ("5387380") or ("5775402") or ("5855933")).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/20 09:01
36	6	(("5031483") or ("5204055") or ("5340656") or ("5387380") or ("5775402") or ("5855933")).PN.	USPAT	2003/03/20 09:01
37	0	((("5031483") or ("5204055") or ("5340656") or ("5387380") or ("5775402") or ("5855933")).PN.) and (diffus$5 near2 (bond$5 weld$5))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/20 09:02
44	20	grind$5 same polish$5 same (diffus$5 near2 (bond$5 weld$5))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/20 09:11
51	1	grind$5 same polish$5 same (diffus$5 near2 (bond$5 weld$5)) same titanium	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/20 09:12
58	0	(demray).in. and (diffus$5 near2 bond$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/20 09:12

65	15	(d maray).in. and (diffus$5 near2 b nd$5)	USPAT; US-PGPUB; EPO; JP ; DERWENT; IBM_TDB	2003/03/20 09:13
72	1	((d maray).in. and (diffus$5 near2 bond$5)) and (grind$5 same polish$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/20 09:13
-	1655	((228/119) or (228/141.1) or (228/193) or (228/195) or (29/592+) or (29/700+)).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/20 08:35
-	166355	(29/$).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/18 16:34
-	987	((((228/119) or (228/141.1) or (228/193) or (228/195) or (29/592+) or (29/700+)).CCLS.) ((29/$).ccls.)) and (diffus$5 near2 bond$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/18 16:34
-	546	steel with (diffus$5 near2 bond$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/18 16:35
-	81	(((((228/119) or (228/141.1) or (228/193) or (228/195) or (29/592+) or (29/700+)).CCLS.) ((29/$).ccls.)) and (diffus$5 near2 bond$5)) and (steel with (diffus$5 near2 bond$5))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/18 16:35
-	189	tool$6 with (diffus$5 near2 bond$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/18 19:32
-	175	mold$6 with (diffus$5 near2 bond$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/18 16:38
-	10	(tool$6 with (diffus$5 near2 bond$5)) and (mold$6 with (diffus$5 near2 bond$5))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/18 17:09

-	41	(j seph with bak).in. (neil with baldwin).in. (james with beals).in. (zissis with dardas).in. (wayde with schmidt).in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/18 16:41
-	2	((j s ph with bak).in. (n il with baldwin).in. (james with beals).in. (zissis with dardas).in. (wayde with schmidt).in.) and (diffus$5 near2 bond$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/18 16:42
-	1	("5849238").PN.	USPAT	2003/03/18 18:17
-	1	("5031483").PN.	USPAT	2003/03/18 18:17
-	65	(((((228/119) or (228/141.1) or (228/193) or (228/195) or (29/592+) or (29/700+)).CCLS.) ((29/$).ccls.)) and (diffus$5 near2 bond$5)) and (tool$6 with (diffus$5 near2 bond$5))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/18 19:32
-	1	steel same carbon same silicon same manganese same molybedenum same vanadium	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/19 21:38
-	676	(s7 a2 m2 w2 h13 d2 d3) near2 steel	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/19 21:39
-	13201	beryllium with copper	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/19 21:41
-	355728	titanium	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/19 21:39
-	1092	(((s7 a2 m2 w2 h13 d2 d3) near2 steel) (beryllium with copper) titanium) same (diffus$5 near2 (bond$5 weld$5))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/19 22:07
-	10164	beryllium near2 copper	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/19 21:41
-	697	(((s7 a2 m2 w2 h13 d2 d3) near2 st l) (b ryllium with copper) titanium) with (diffus$5 near2 (b nd$5 weld$5))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/19 21:41

.	685	(((s7 a2 m2 w2 h13 d2 d3) near2 st l) (beryllium n ar2 copper) titanium) with (diffus$5 near2 (b nd$5 w ld$5))	USPAT; US-PGPUB; EPO; JP ; DERWENT; IBM_TDB	2003/03/19 21:42
.	454	(((s7 a2 m2 w2 h13 d2 d3) n ar2 steel) (beryllium near2 copper) titanium) with (diffus$5 near2 (bond$5 weld$5))	USPAT	2003/03/19 21:45
.	27	((((s7 a2 m2 w2 h13 d2 d3) near2 steel) (beryllium near2 copper) titanium) with (diffus$5 near2 (bond$5 weld$5))) same mold$6	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/19 22:06
.	20	grind$5 same polish$5 same (diffus$5 near2 (bond$5 weld$5))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/19 22:08